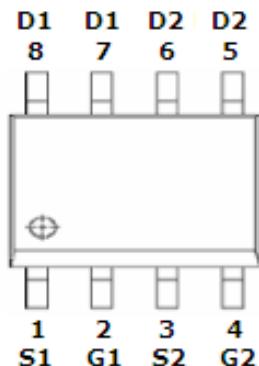


SCRIPTION

STP6625 is the P-Channel logic enhancement mode power field effect transistor which is produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application, notebook power management and battery powered circuits where high-side switching.

PIN CONFIGURATION SOP-8



FEATURE

- -60V/-5.0A, $R_{DS(ON)} = 60m\Omega$ (Typ.) @ $V_{GS} = -10$
- -60V/-3.0A, $R_{DS(ON)} = 85m\Omega$ @ $V_{GS} = -4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOP-8 package design

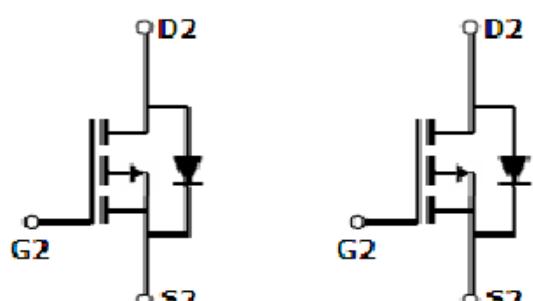
PART MARKING SOP-8



Y: Year Code

A: Date Code

Q: Process Code



P-Channel

P-Channel



STP6625 Pb
Lead-free

P Channel Enhancement Mode MOSFET

-5.0A

ABSOULTE MAXIMUM RATINGS (Ta = 25°C Unless otherwise noted)

Parameter		Symbol	Typical	Unit
Drain-Source Voltage		V _{DSS}	-60	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current (T _J =150°C)	T _A =25°C T _A =70°C	I _D	-5.0 -4.0	A
Pulsed Drain Current		I _{DM}	-25	A
Continuous Source Current (Diode Conduction)		I _S	-3	A
Power Dissipation	T _A =25°C T _A =70°C	P _D	2.3 1.3	W
Operation Junction Temperature		T _J	-55/150	°C
Storage Temperature Range		T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient		R _{θJA}	70	°C/W



STP6625 Pb Lead-free

P Channel Enhancement Mode MOSFET

-5.0A

ELECTRICAL CHARACTERISTICS (Ta = 25°C Unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =-250uA	-60			V	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250 uA	-0.8		-2.5	V	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-48V, V _{GS} =0V			-1	uA	
		V _{DS} =-48V, V _{GS} =0V T _J =85°C			-10		
Drain-source On-Resistance	R _{DSS(on)}	V _{GS} =-10V, I _D =-5A V _{GS} =-4.5V, I _D =-3A		0.060 0.085	0.072 0.095	Ω	
Forward Tran Conductance	g _{fs}	V _{DS} =-5V, I _D =-6.7A		18		S	
Diode Forward Voltage	V _{SD}	I _s =-2.3A, V _{GS} =0V		-0.7	-1.0	V	
Dynamic							
Total Gate Charge	Q _g	V _{DS} =-30V, V _{GS} =-10 I _D ≡ -6.2A		45		nC	
Gate-Source Charge	Q _{gs}			5.2			
Gate-Drain Charge	Q _{gd}			9.3			
Input Capacitance	C _{iss}	V _{DS} = -30V, V _{GS} =0V f=1MHz		2010		pF	
Output Capacitance	C _{oss}			130			
Reverse TransferCapacitance	C _{rss}			105			
Turn-On Time	t _{d(on)} tr	V _{DS} =-30V, R _L =4.7Ω V _{GS} =-10V, R _{GEN} =3Ω		9		nS	
				6.1			
Turn-Off Time	t _{d(off)} tf			44			
				12.9			

TYPICAL CHARACTERISTICS

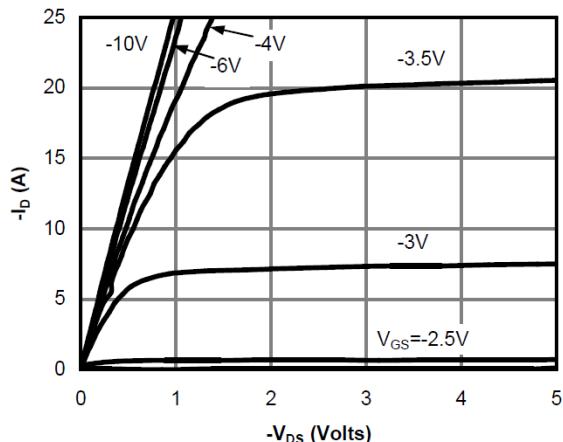


Fig 1: On-Region Characteristics

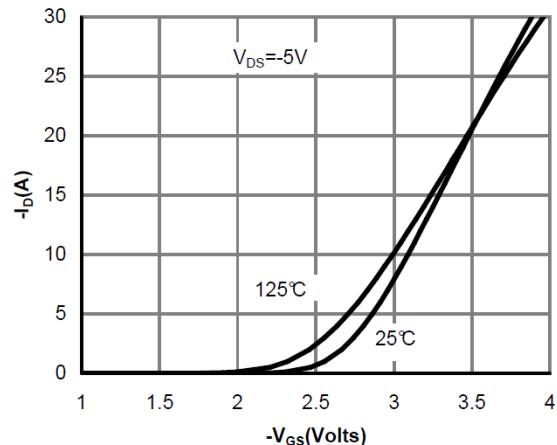


Figure 2: Transfer Characteristics

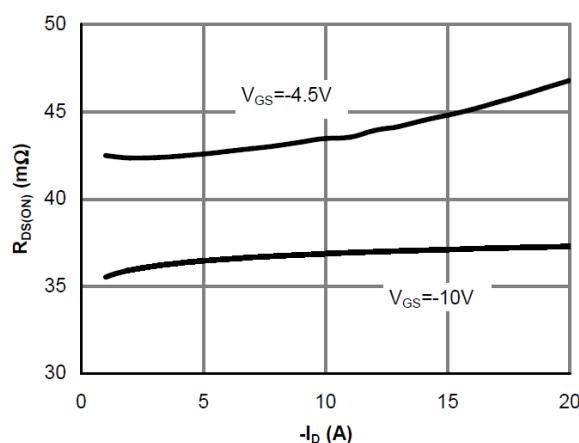


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

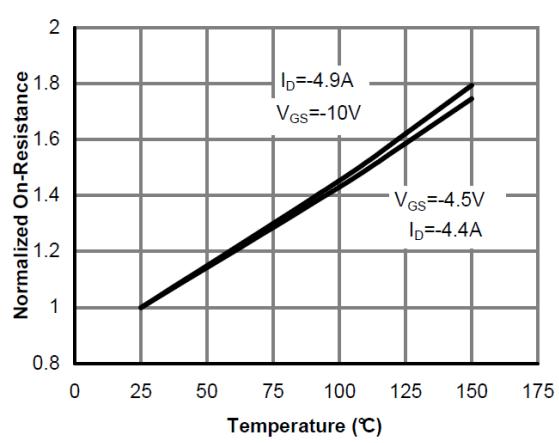


Figure 4: On-Resistance vs. Junction Temperature

TYPICAL CHARACTERISTICS

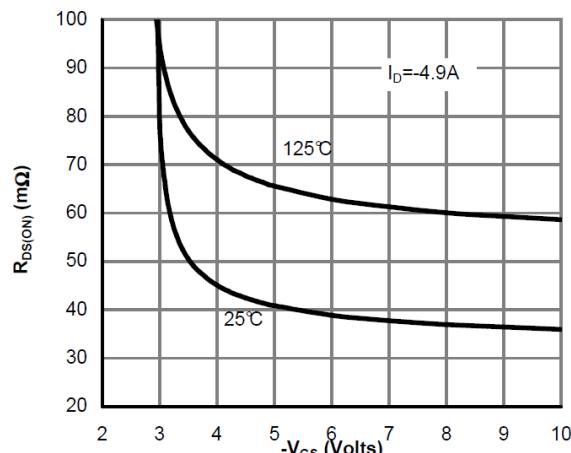


Figure 5: On-Resistance vs. Gate-Source Voltage

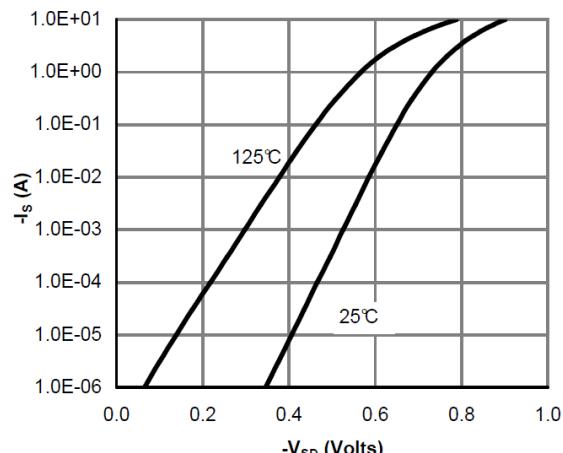


Figure 6: Body-Diode Characteristics

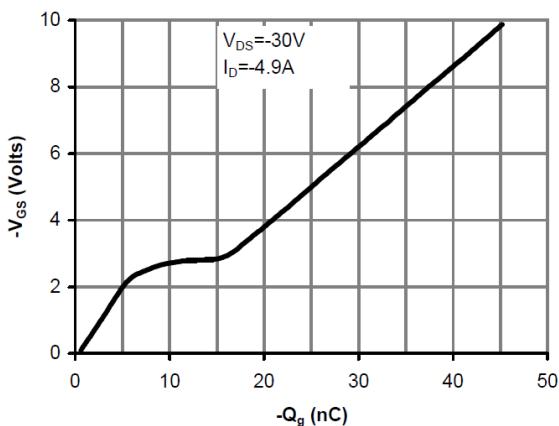


Figure 7: Gate-Charge Characteristics

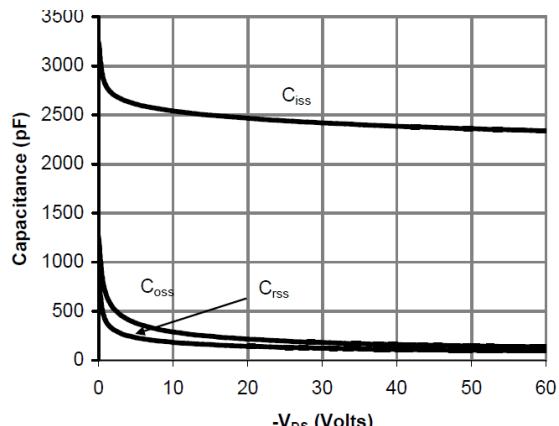


Figure 8: Capacitance Characteristics

TYPICAL CHARACTERISTICS

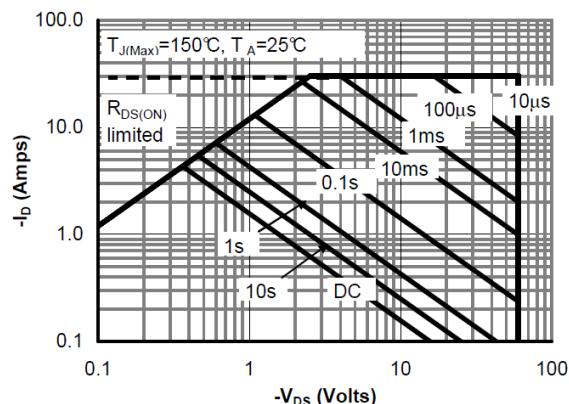


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

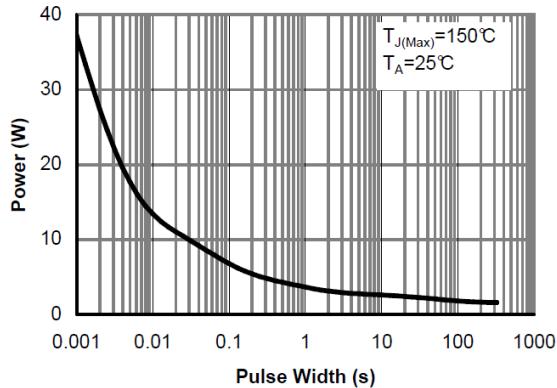


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

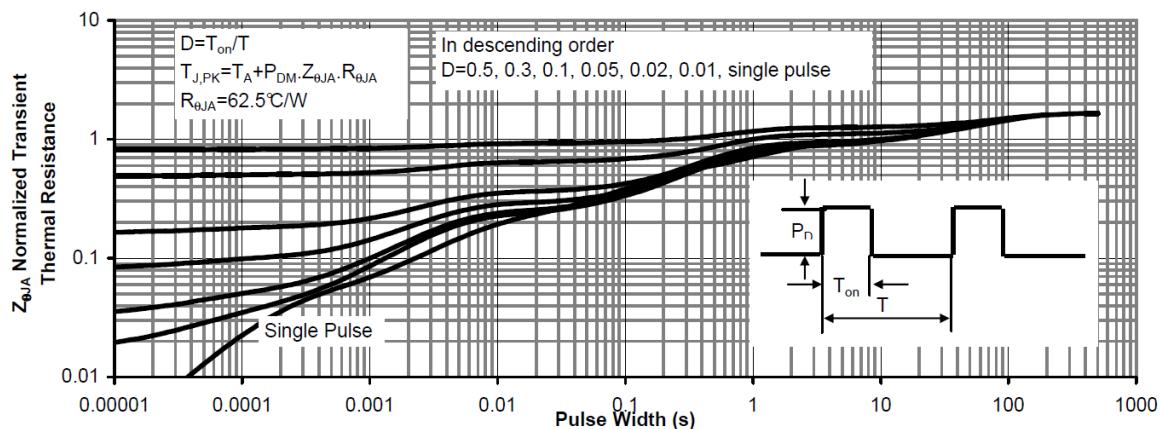


Figure 11: Normalized Maximum Transient Thermal Impedance

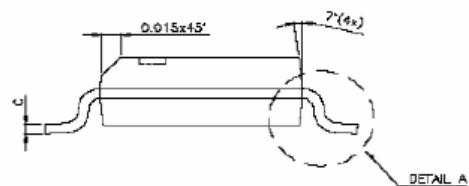
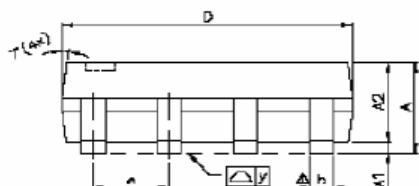
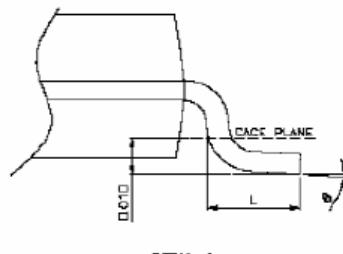
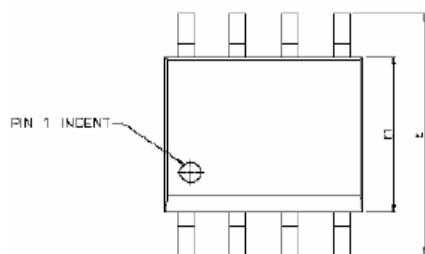


STP6625 Pb
Lead-free

P Channel Enhancement Mode MOSFET

-5.0A

SOP-8 PACKAGE OUTLINE



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.47	1.60	1.73	0.058	0.063	0.068
A1	0.10	—	0.25	0.004	—	0.010
A2	—	1.45	—	—	0.057	—
b	0.33	0.41	0.51	0.013	0.016	0.020
C	0.19	0.20	0.25	0.0075	0.008	0.0098
D	4.80	4.85	4.95	0.189	0.191	0.195
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e	—	1.27	—	—	0.050	—
L	0.38	0.71	1.27	0.015	0.028	0.050
$\triangle y$	—	—	0.076	—	—	0.003
θ	0°	—	8°	0°	—	8°

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